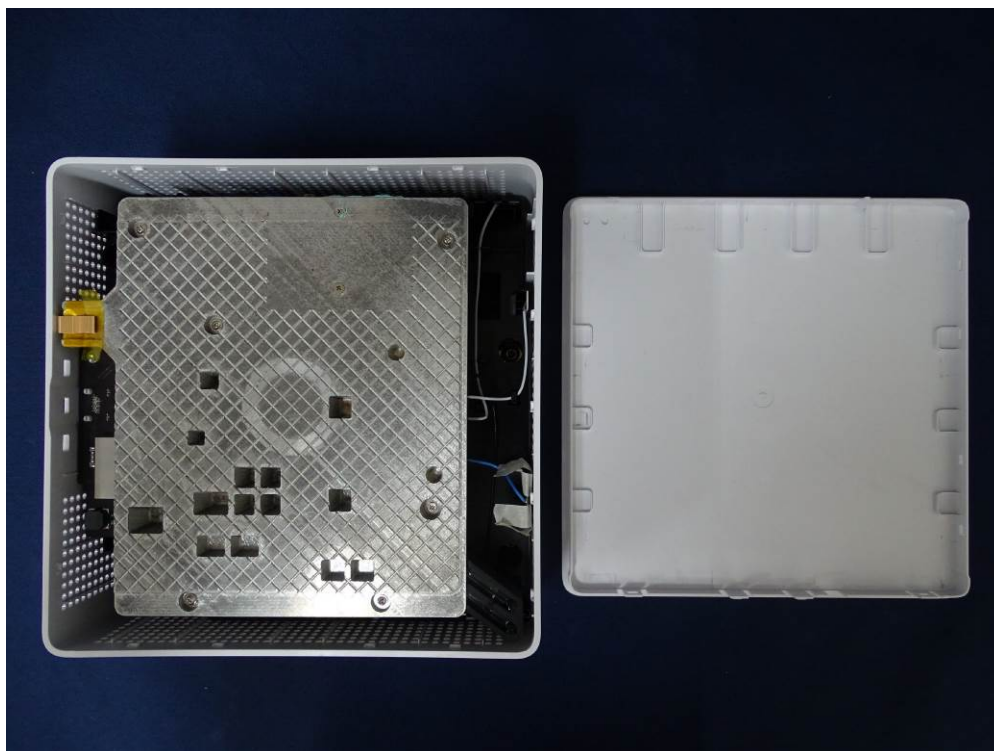
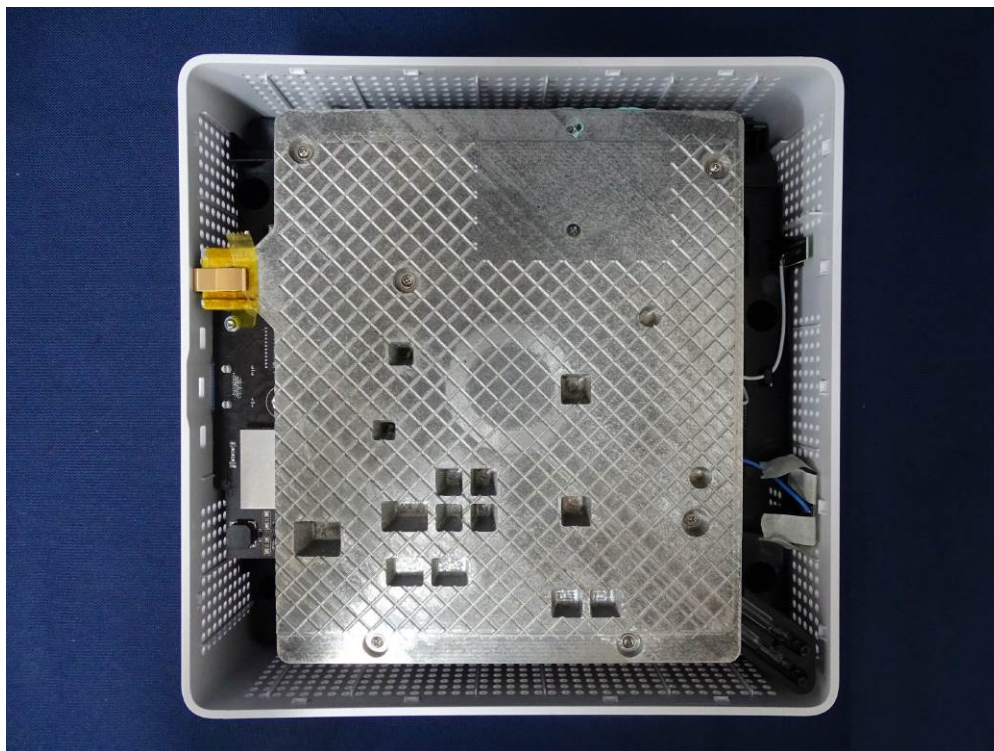


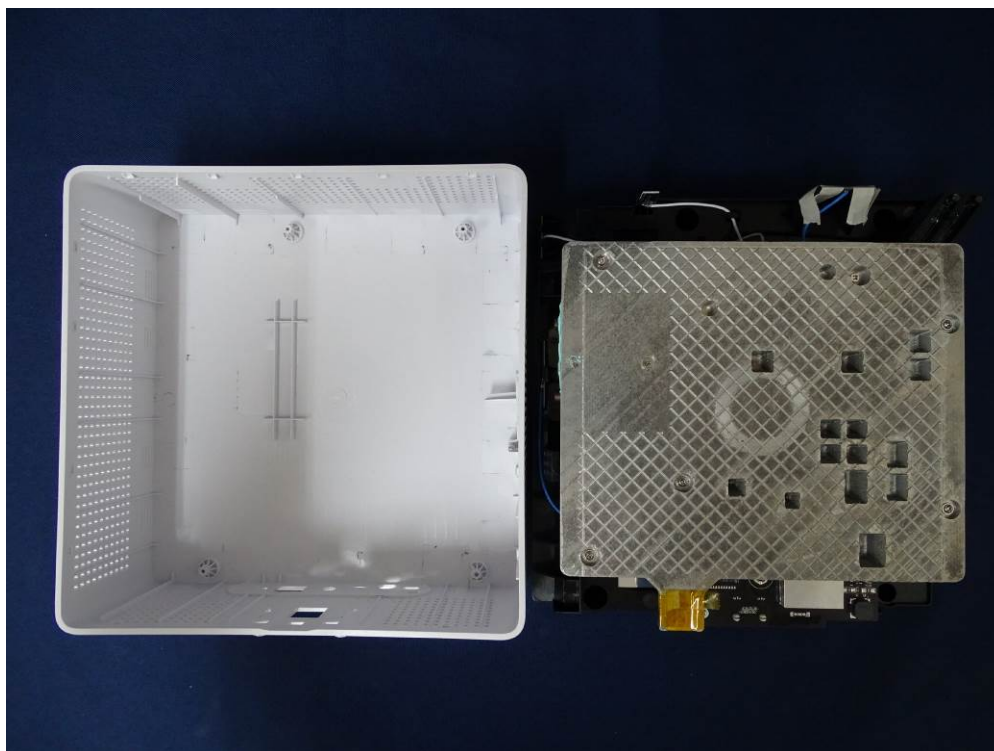
(7) EUT Photo



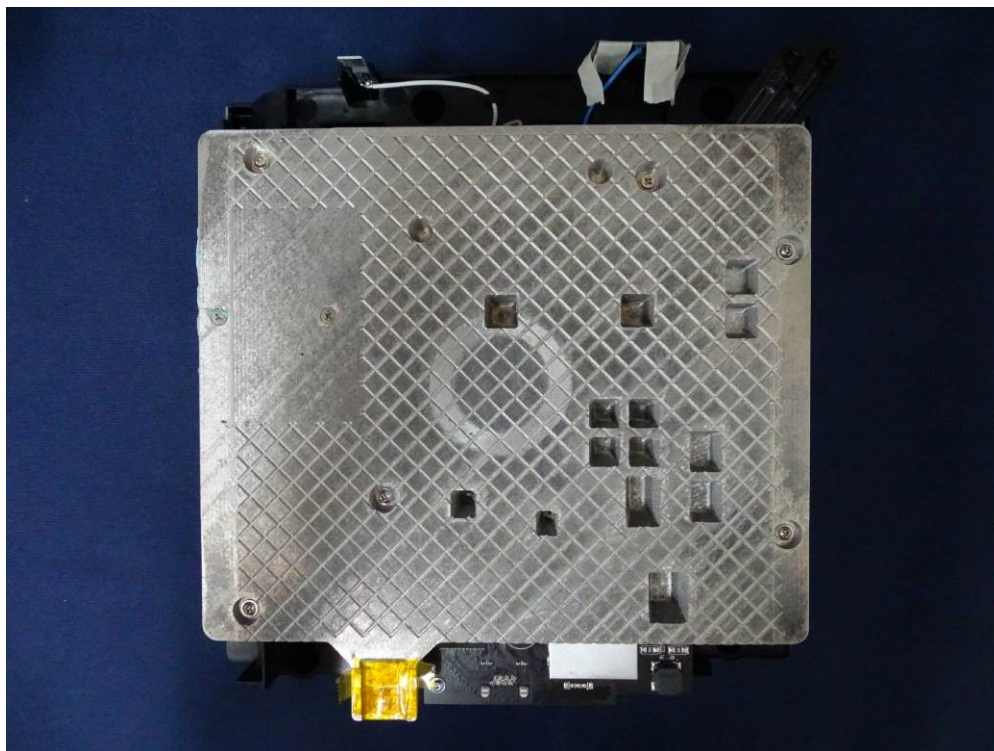
(8) EUT Photo



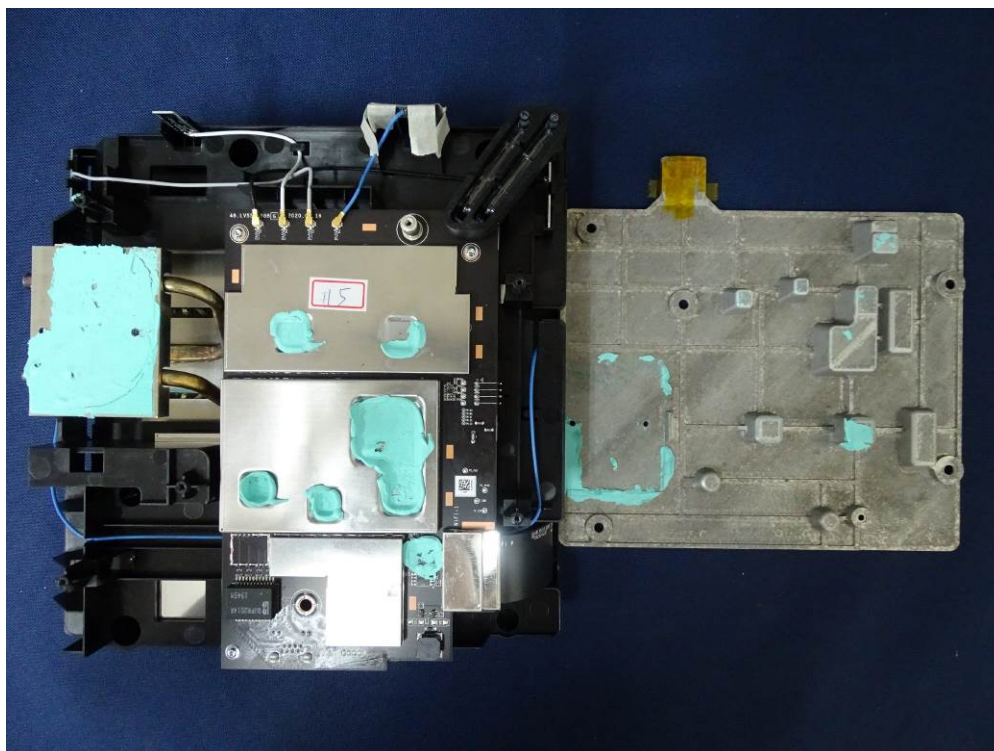
(9) EUT Photo



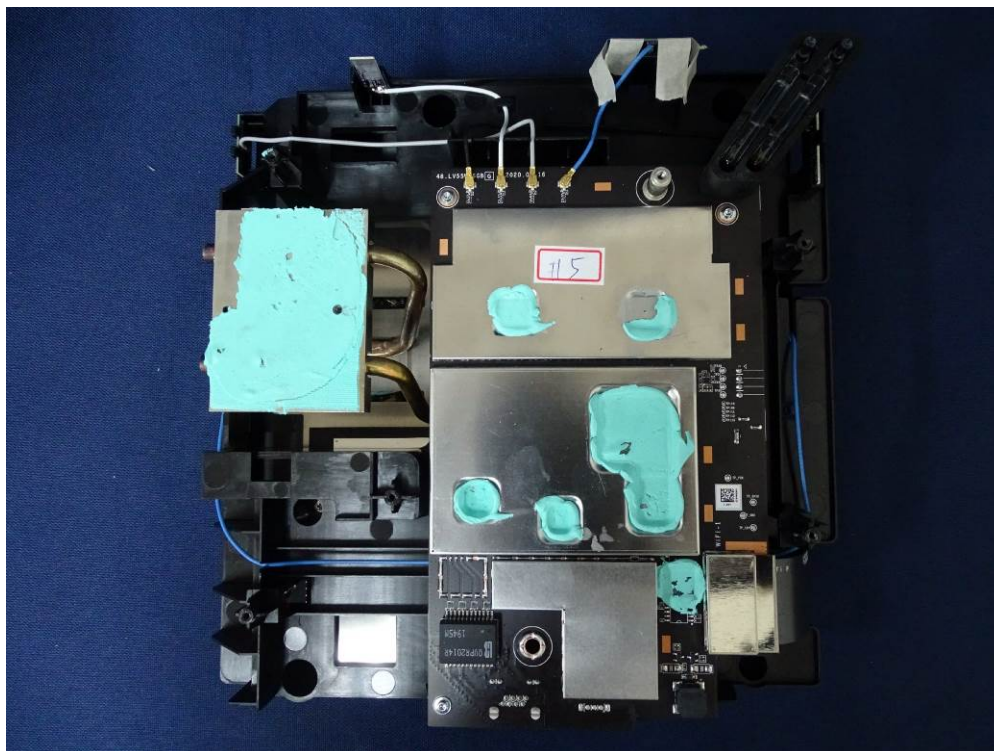
(10) EUT Photo



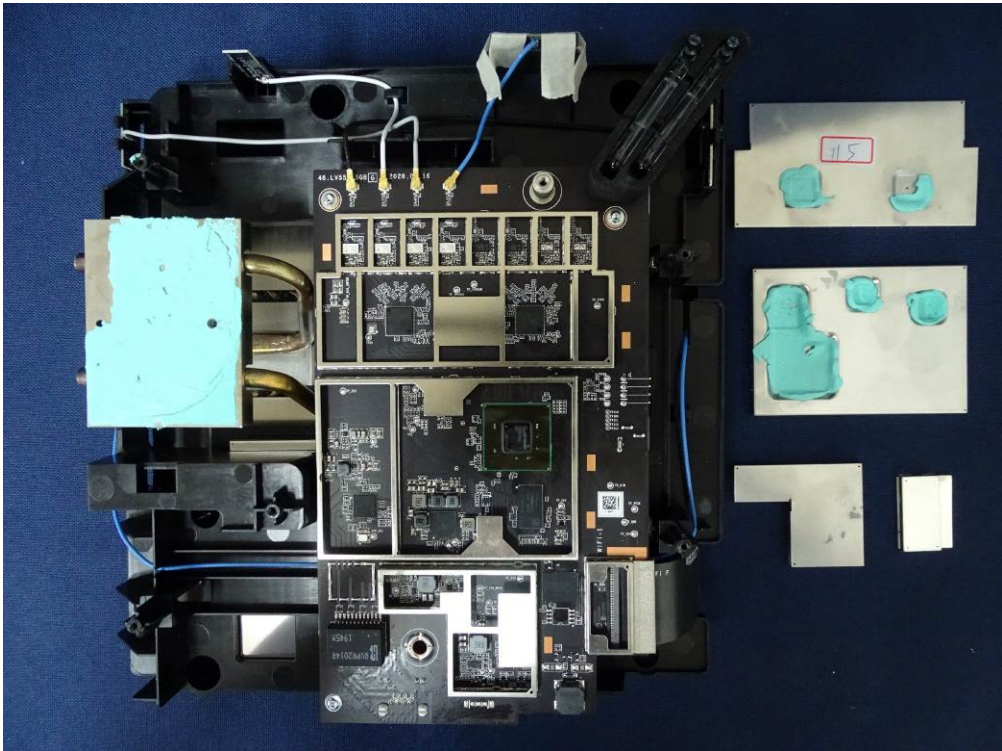
(11) EUT Photo



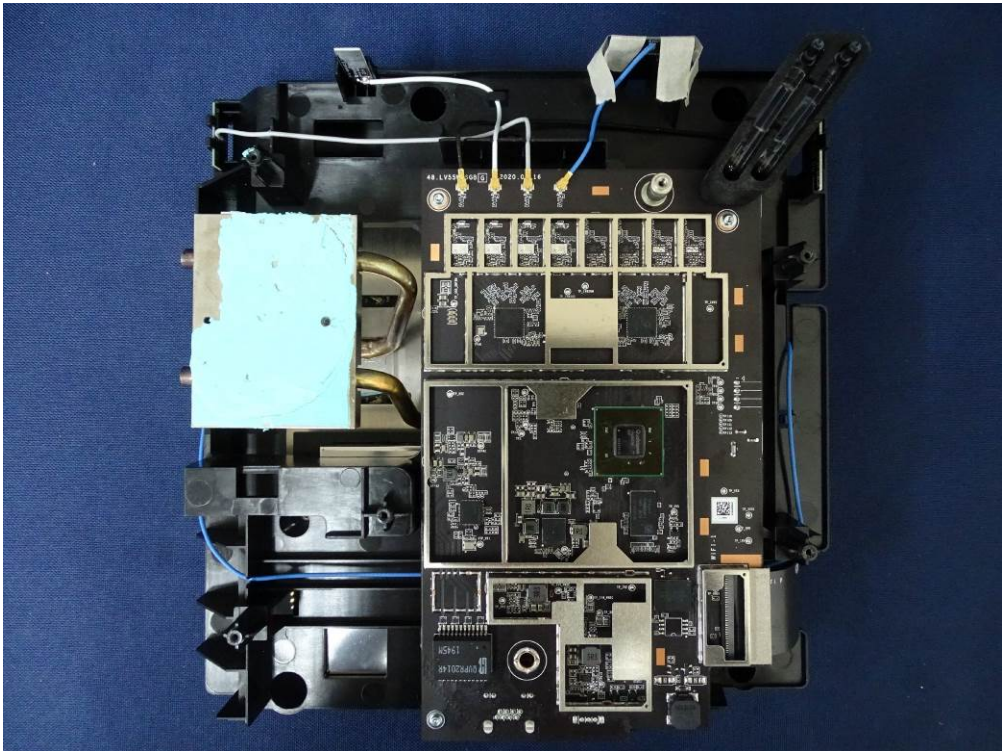
(12) EUT Photo



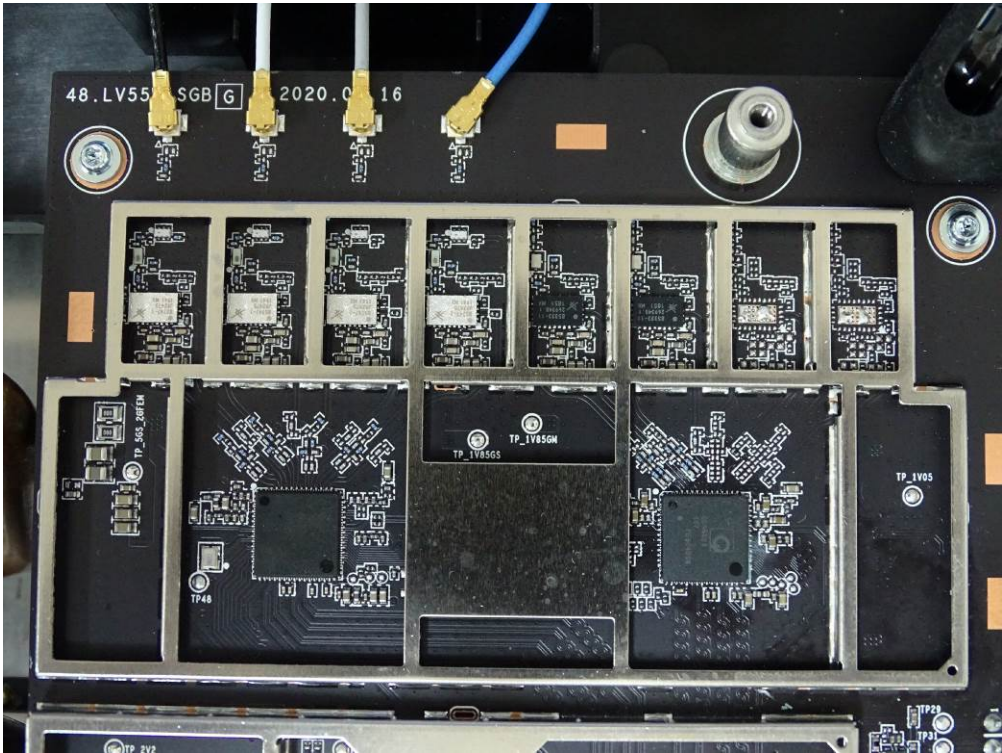
(13) EUT Photo



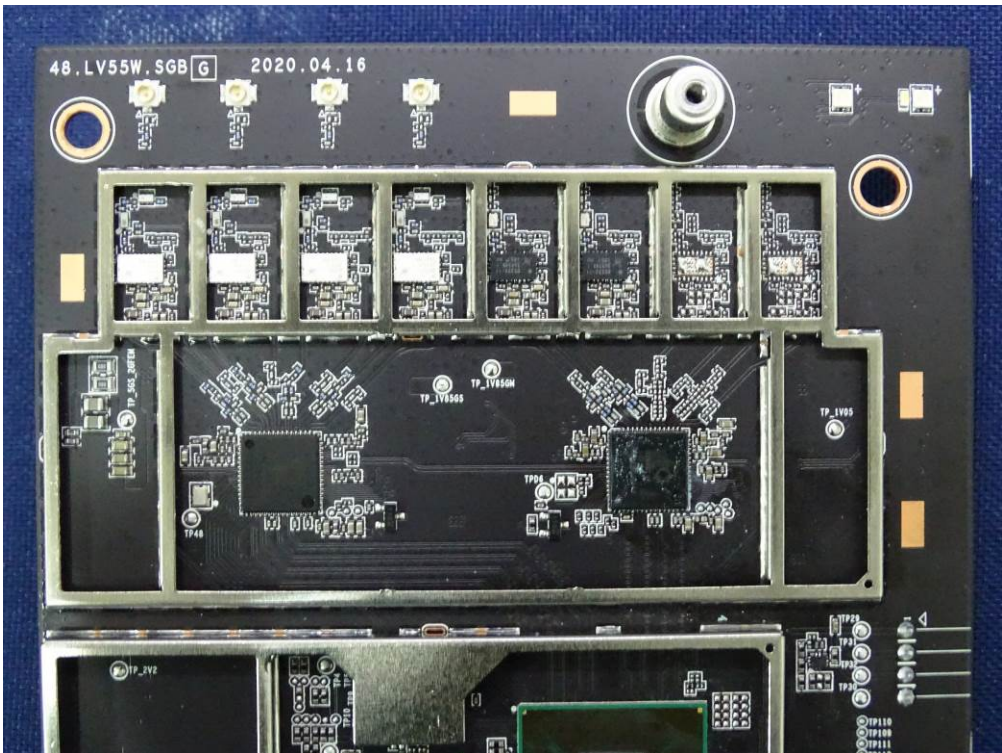
(14) EUT Photo



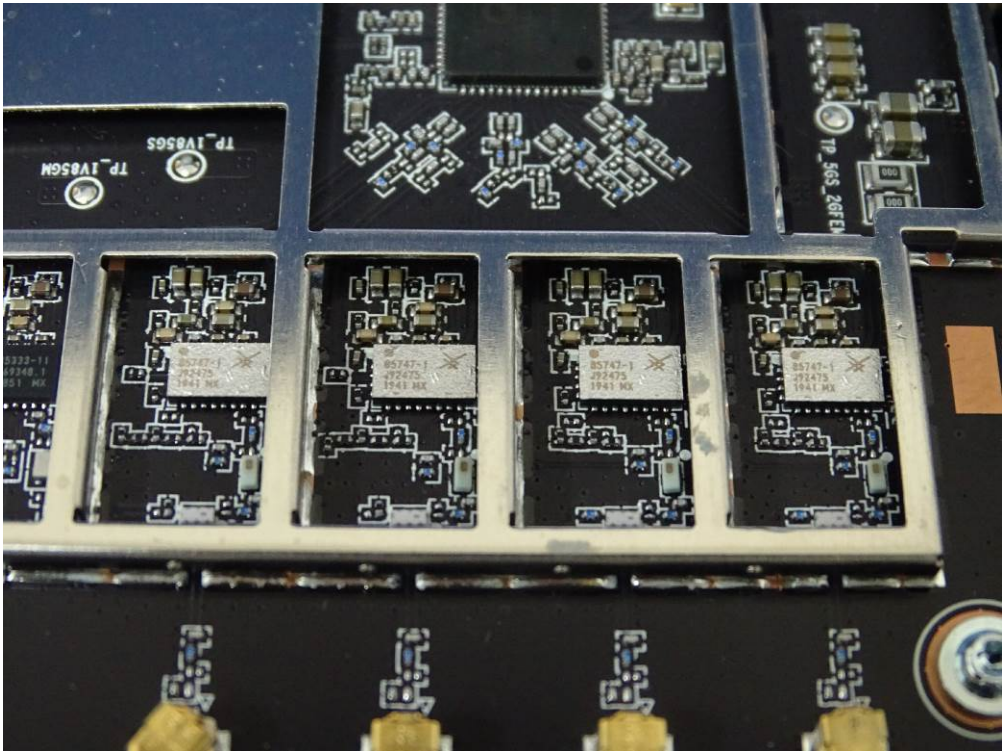
(15) EUT Photo



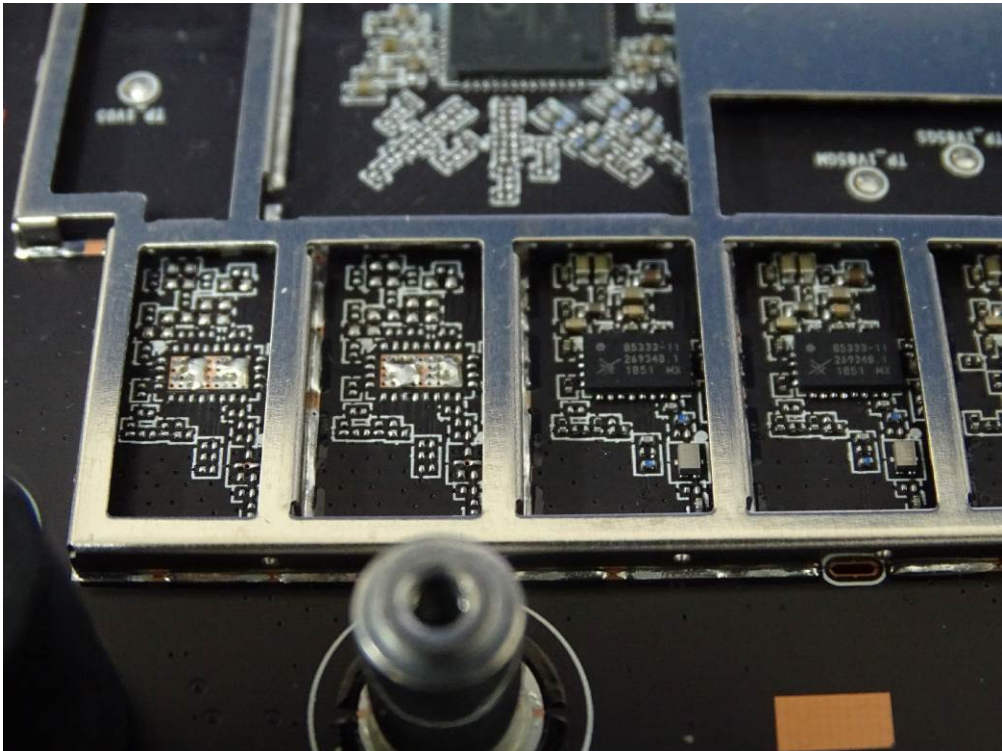
(16) EUT Photo



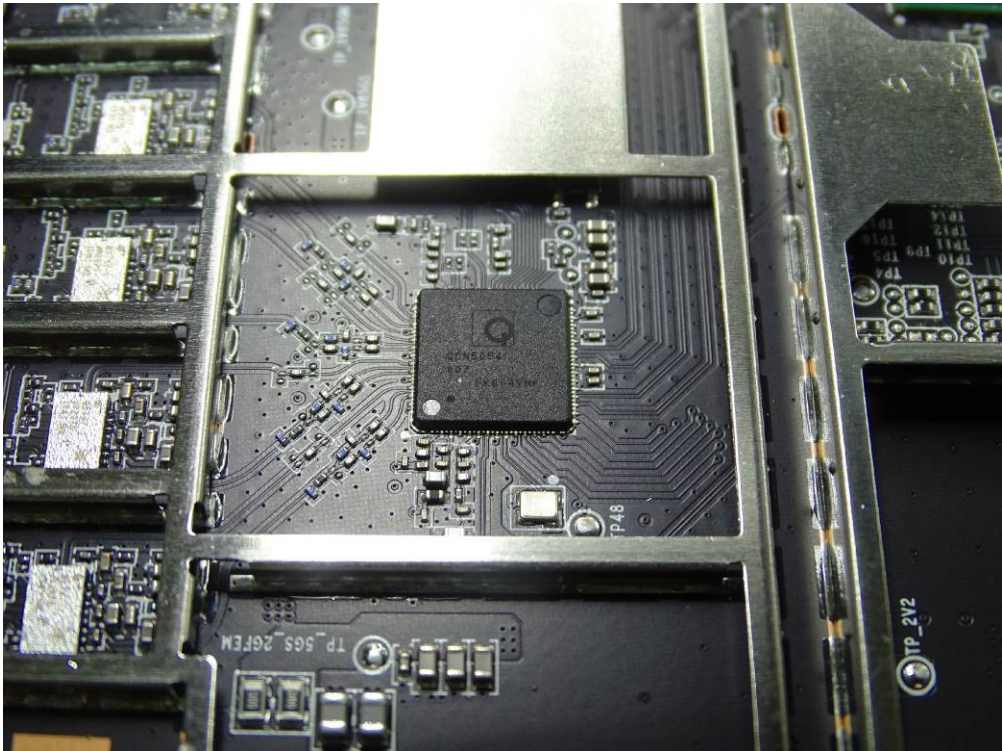
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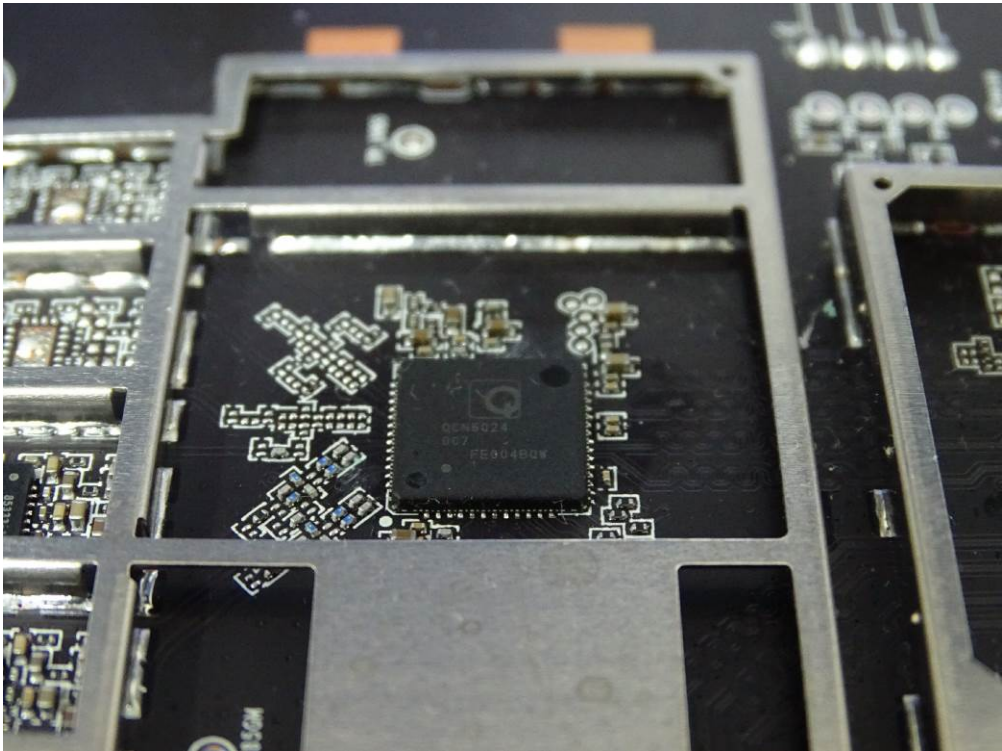
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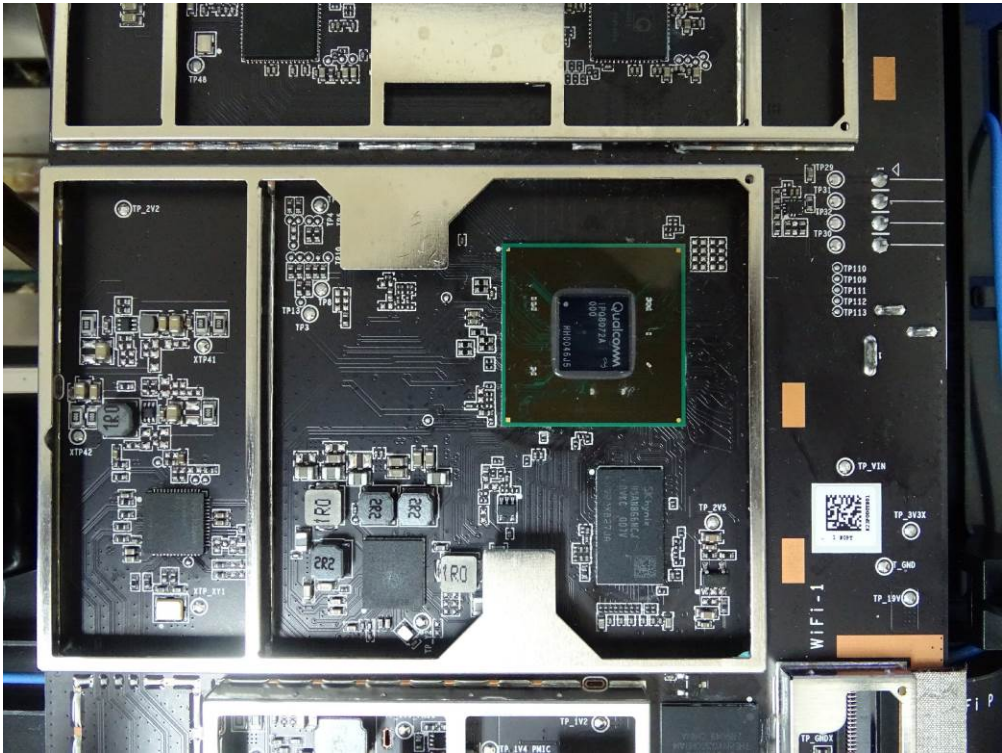
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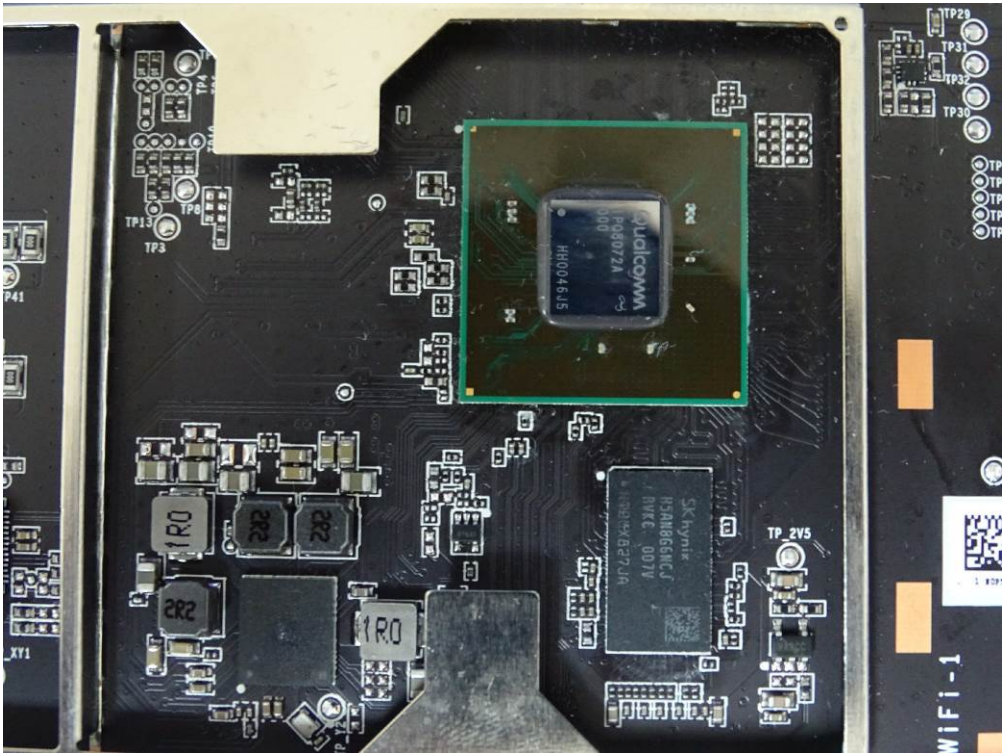
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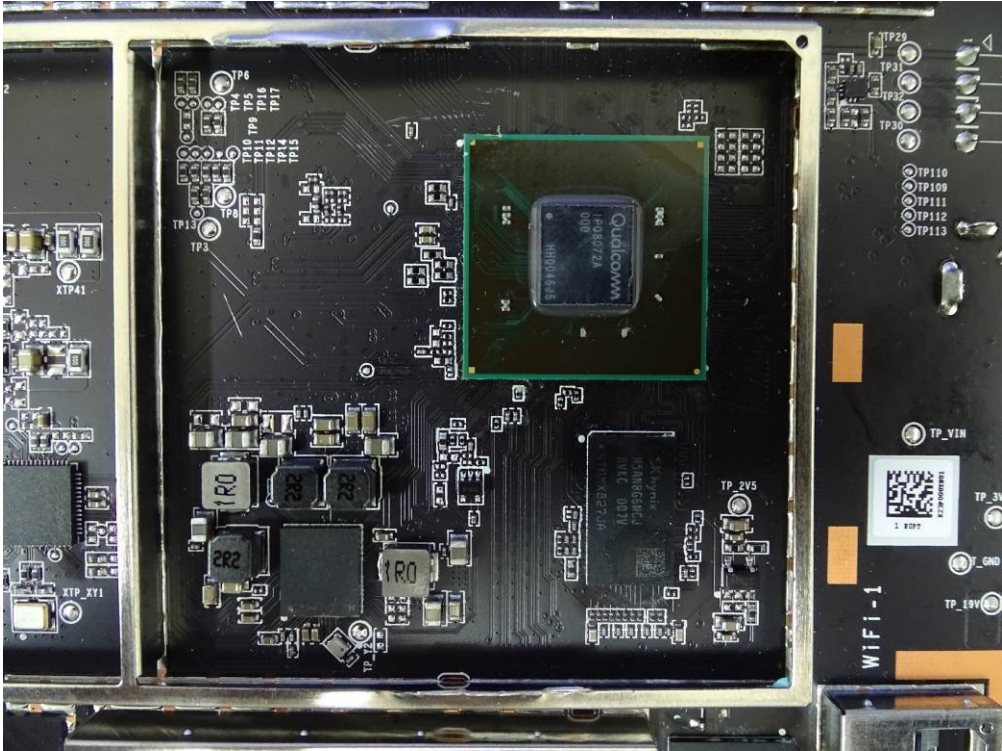
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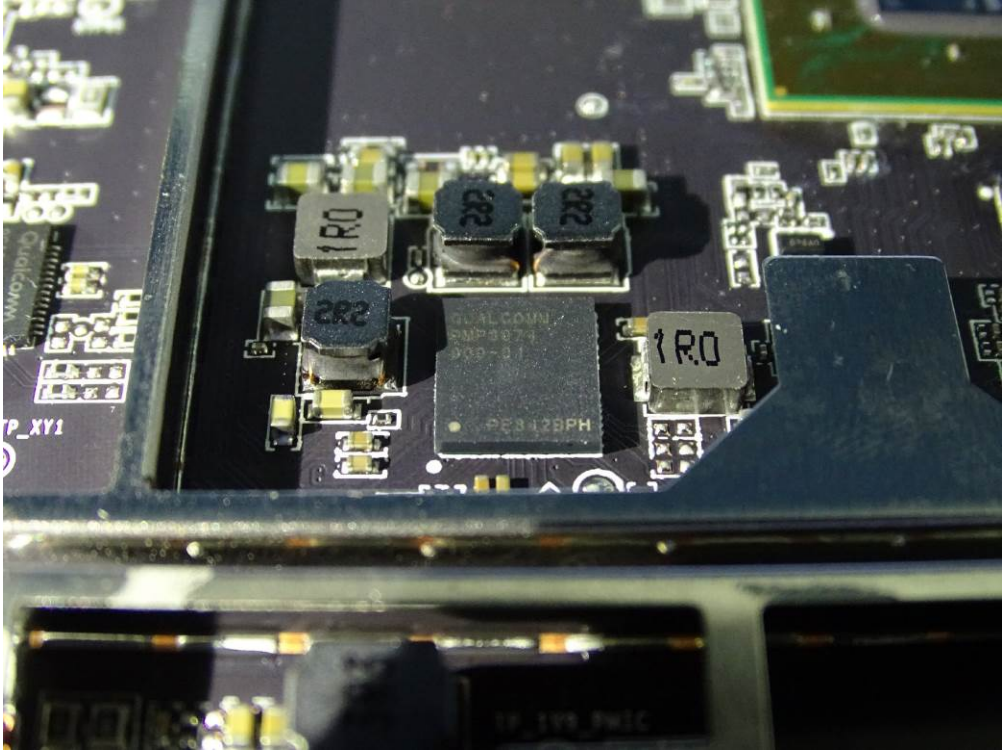
(22) EUT Photo



(23) EUT Photo

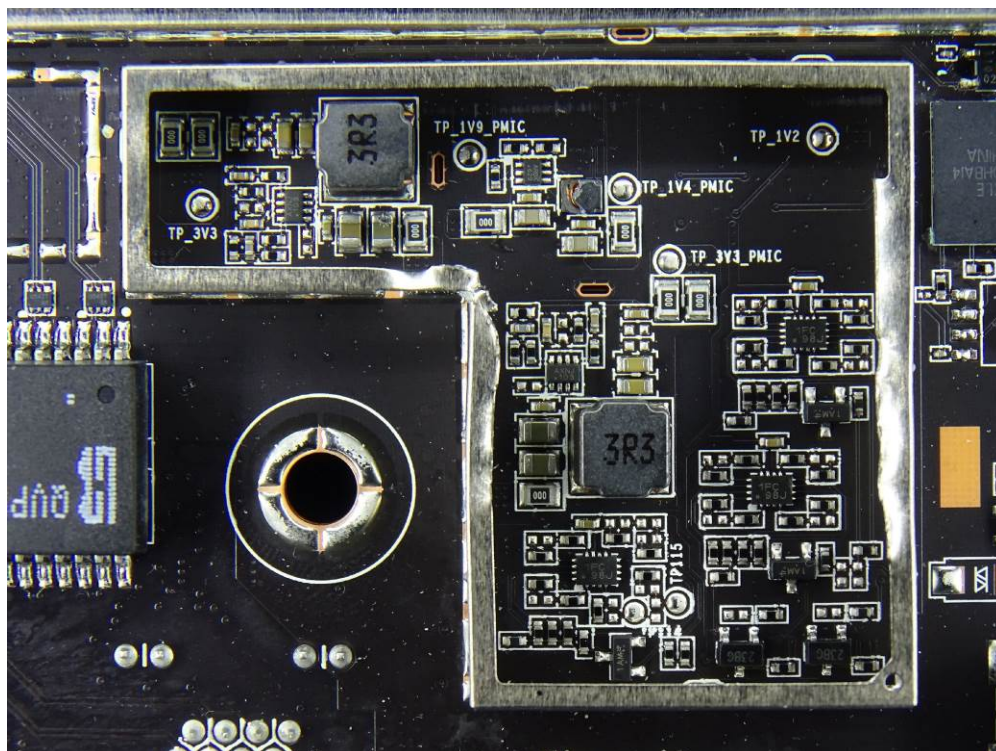


(24) EUT Photo

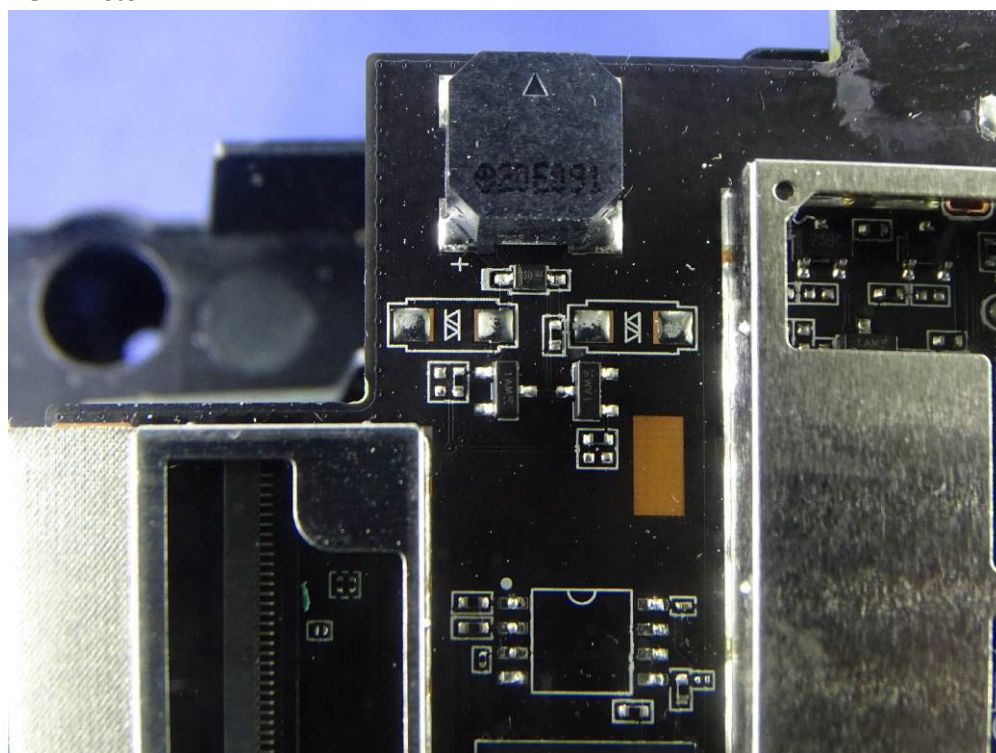


A close-up photograph of a Qualcomm QCA8081 chip mounted on a dark-colored printed circuit board (PCB). The chip is a square integrated circuit with a gold-colored leadless package. It is surrounded by various surface-mount components, including capacitors and resistors. Labels on the PCB include "XTP42" to the left of the chip, "XTP_XY1" below the chip, and "1R0" and "2R2" on components to the right. The chip itself has "Qualcomm" and "QCA8081" printed on its top surface.

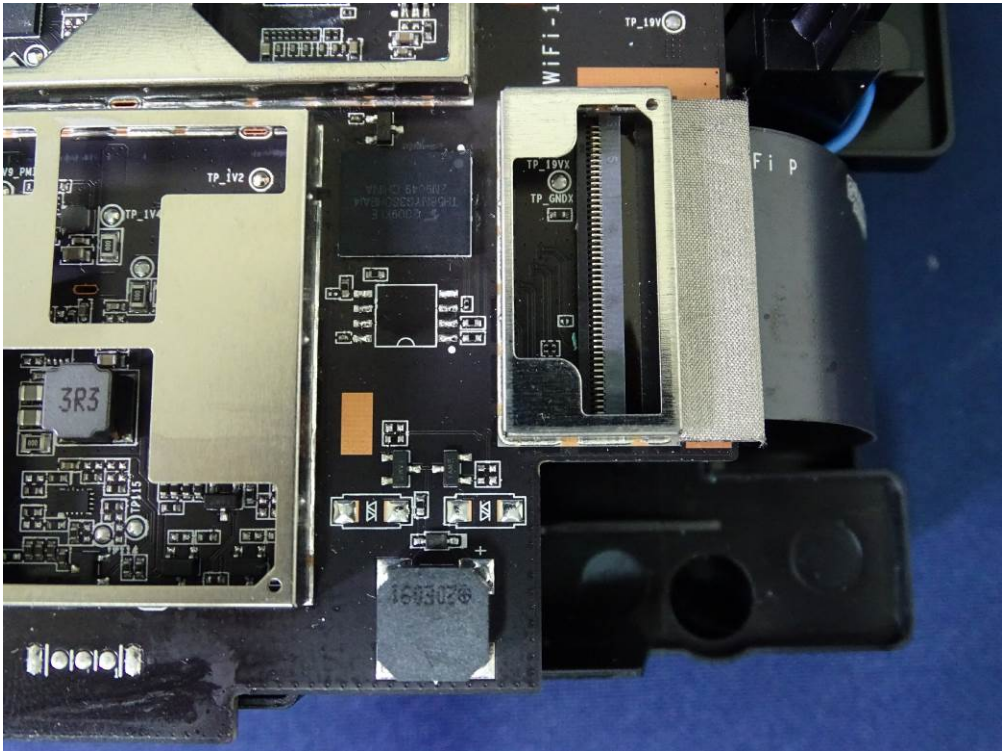
(27) EUT Photo



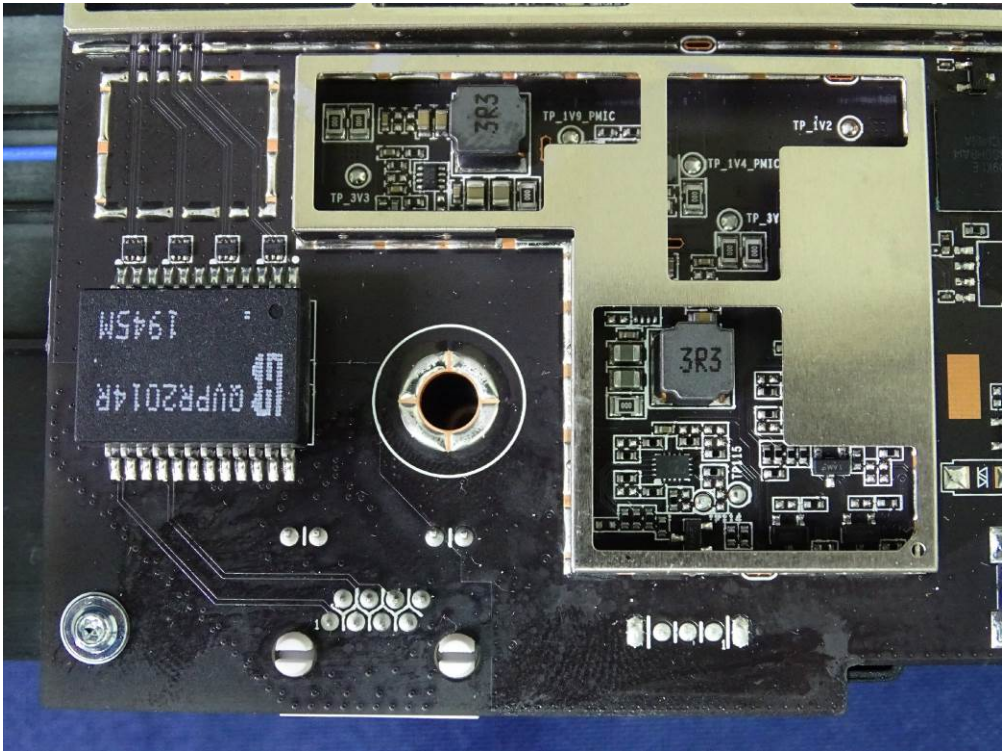
(28) EUT Photo



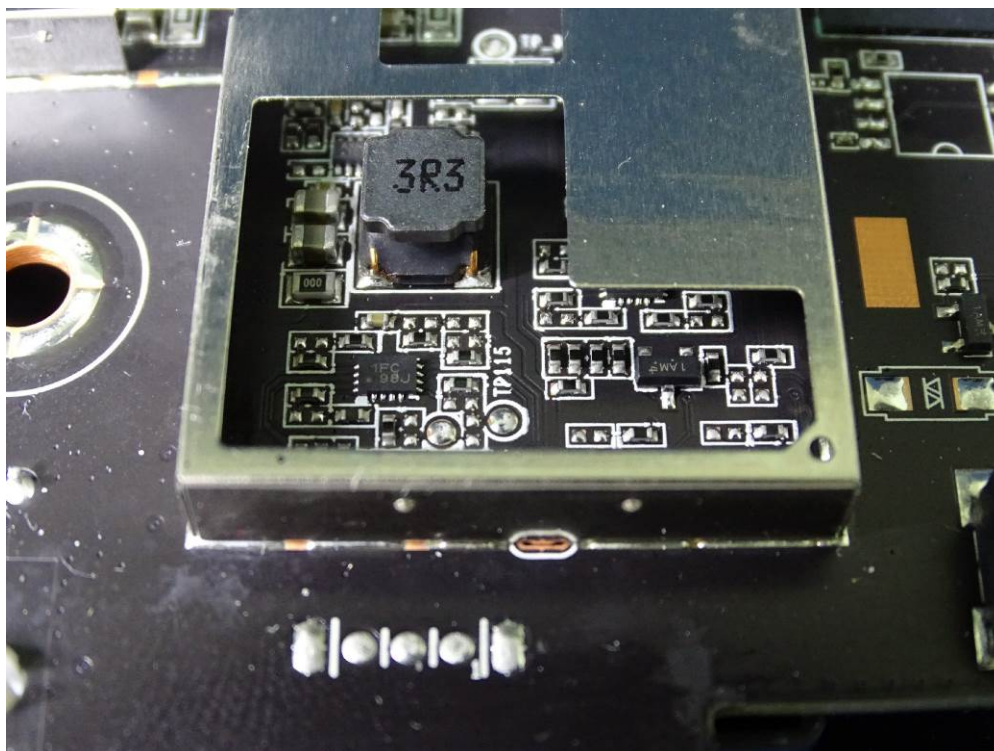
(29) EUT Photo



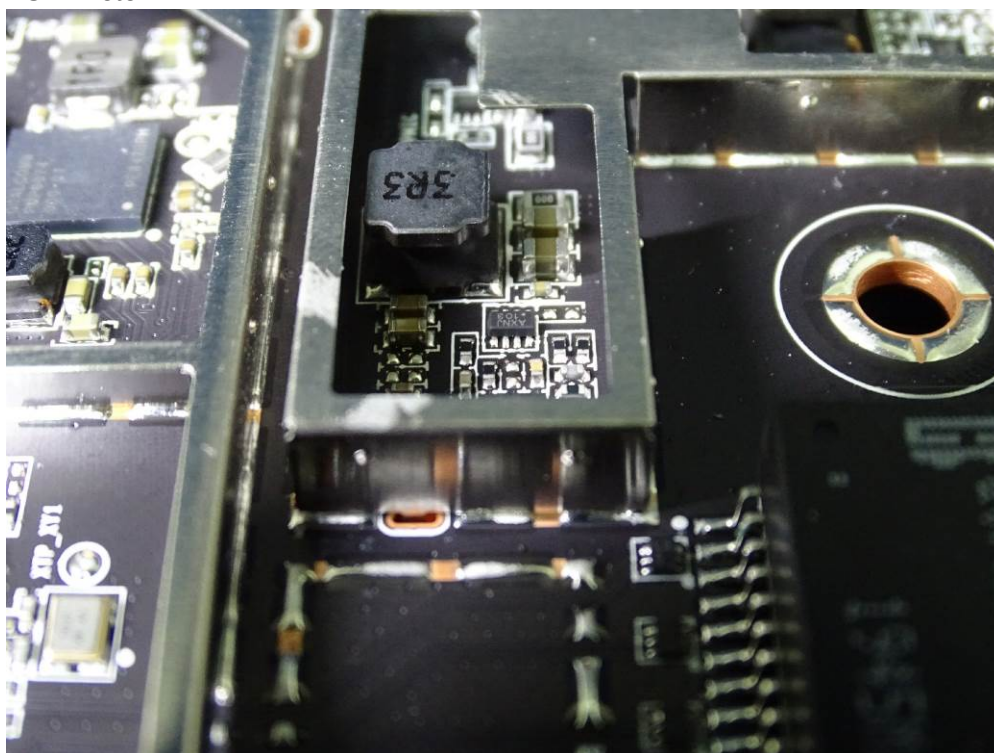
(30) EUT Photo



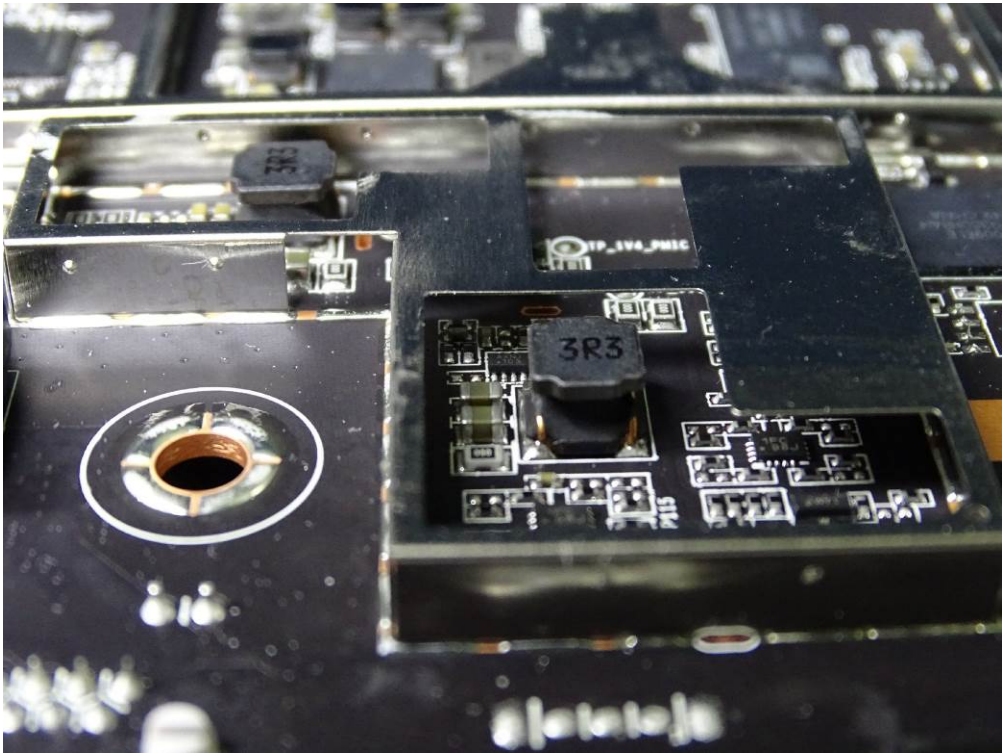
(31) EUT Photo



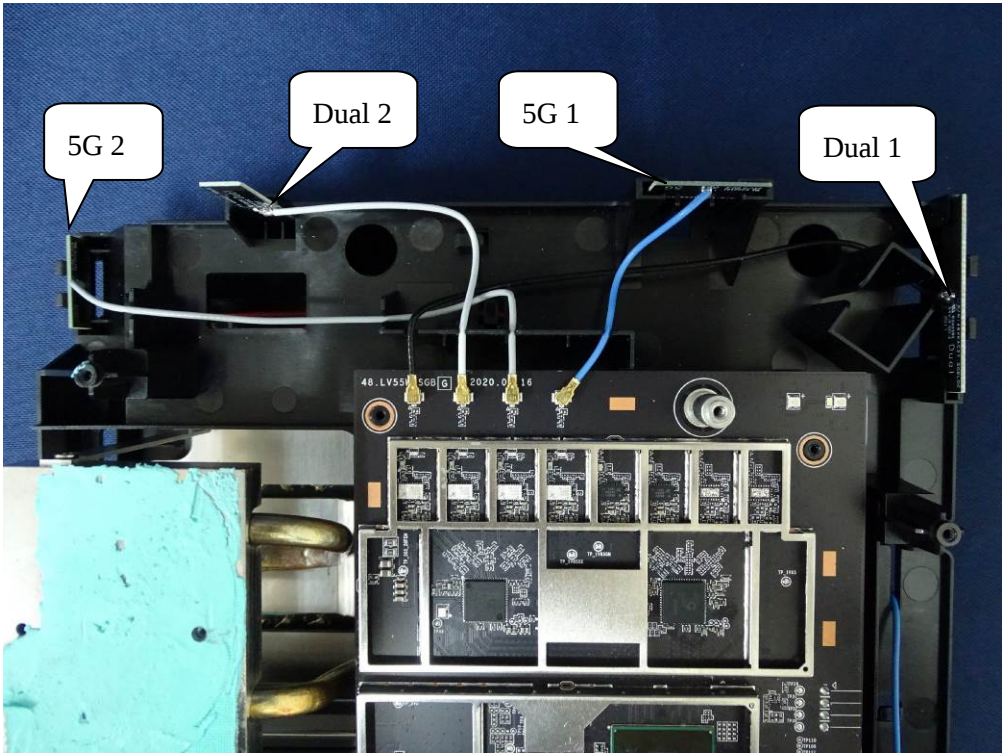
(32) EUT Photo



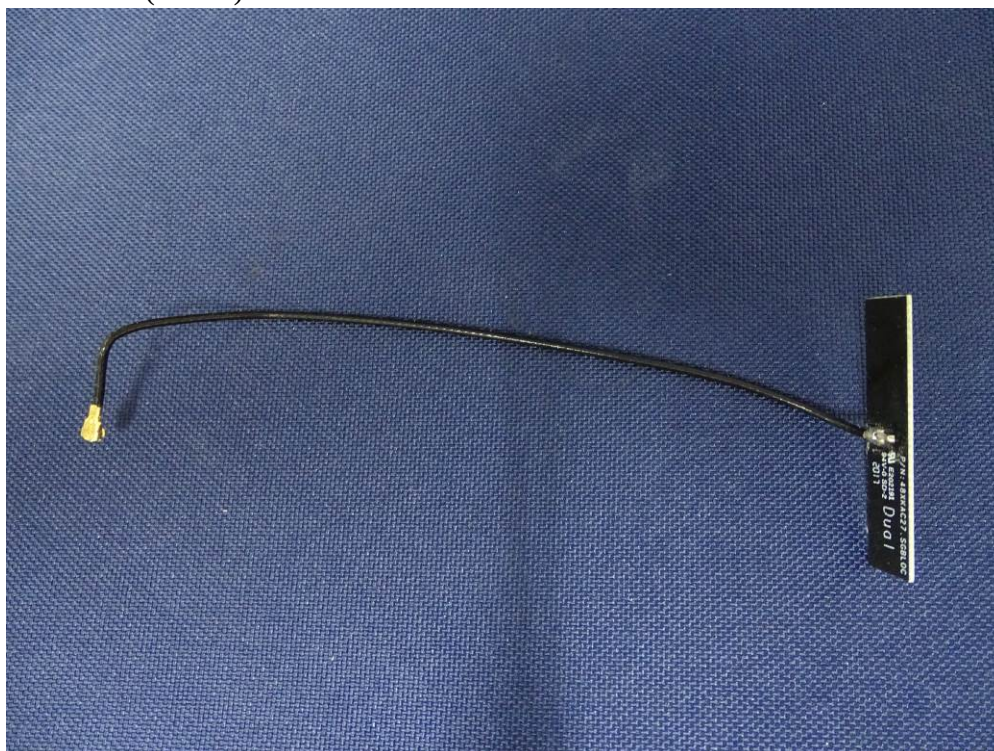
(33) EUT Photo



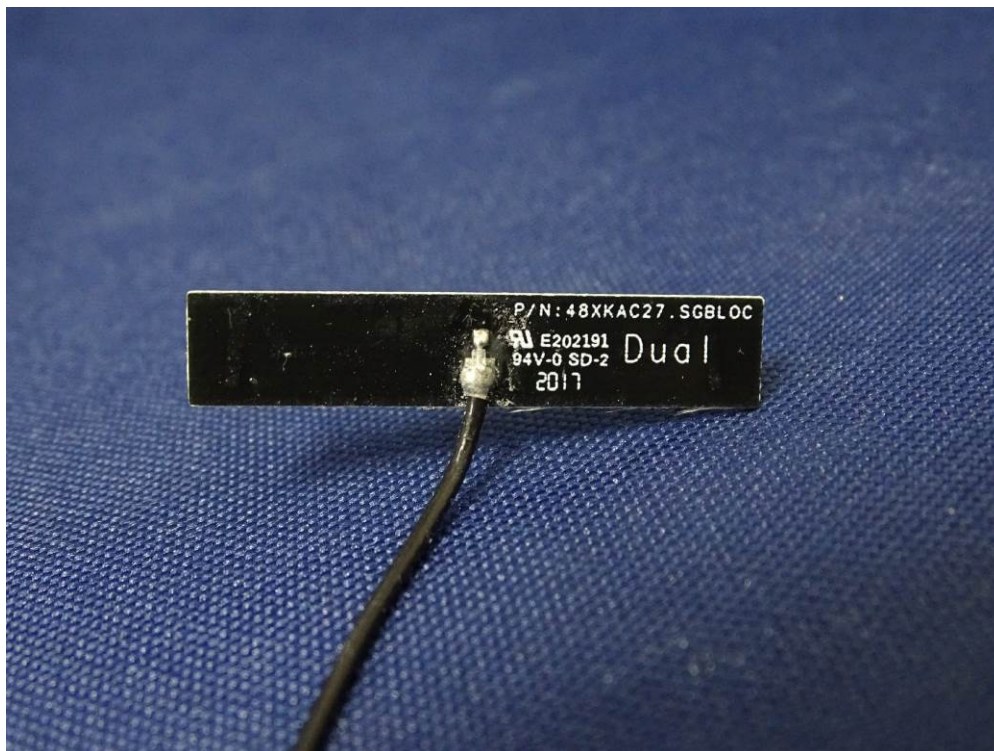
(34) EUT Photo



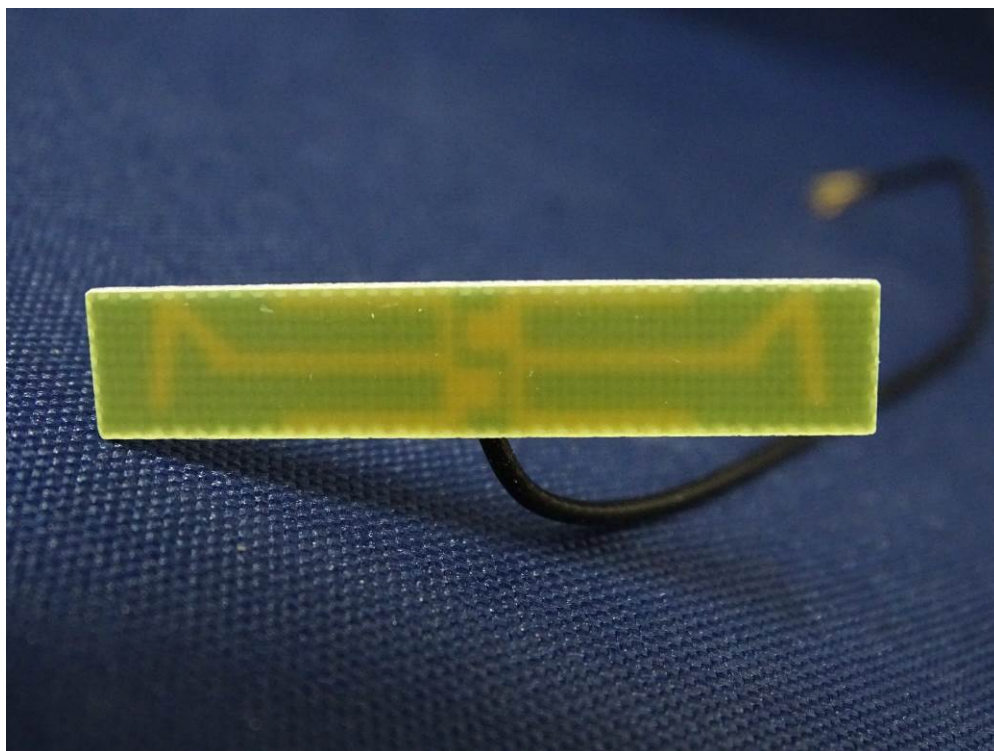
(35) EUT Photo (Dual 1)



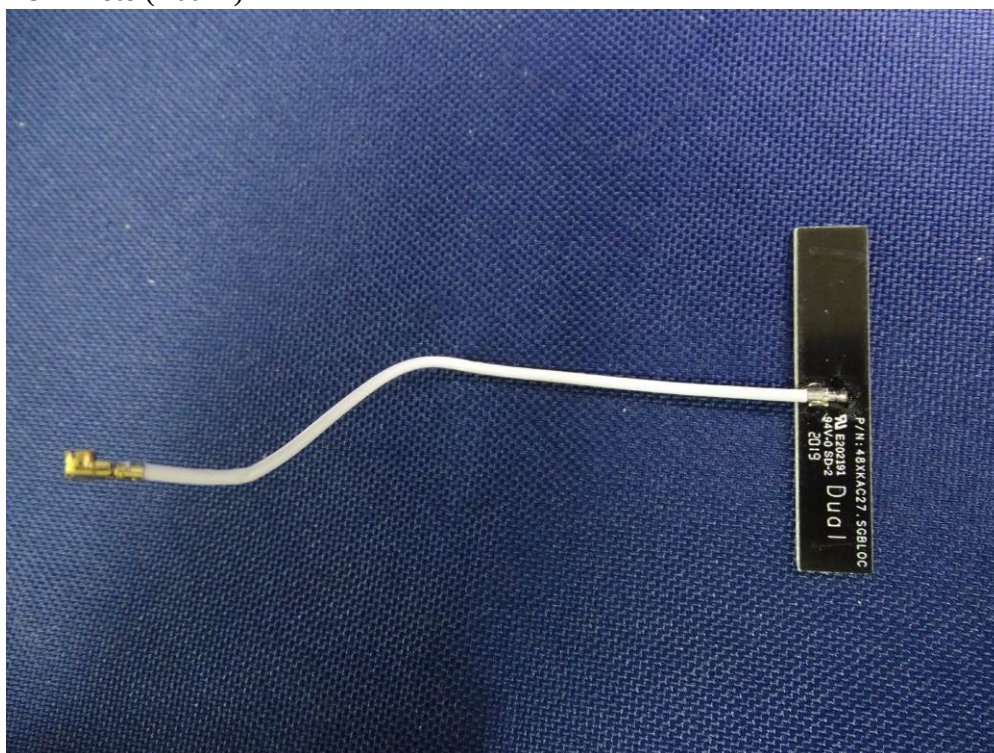
(36) EUT Photo



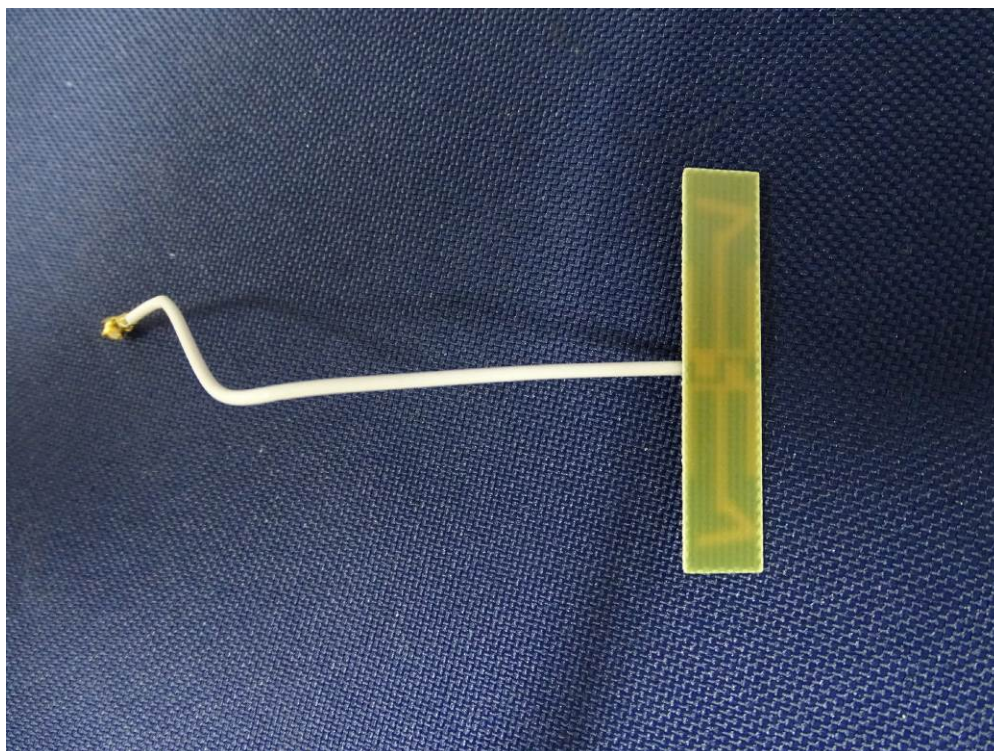
(37) EUT Photo



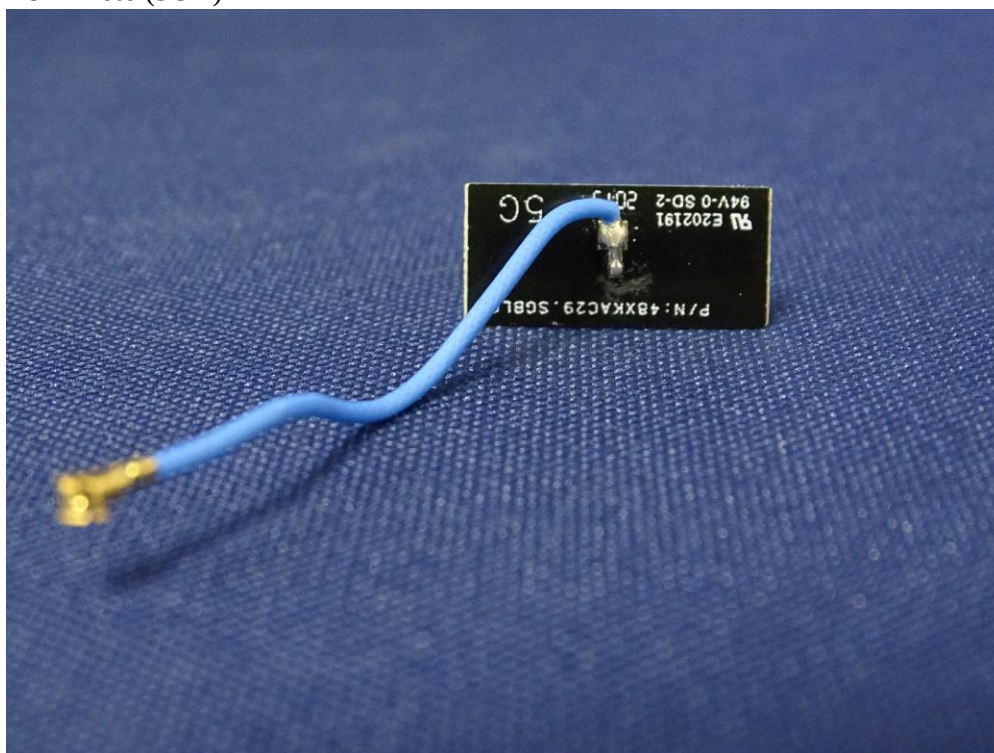
(38) EUT Photo (Dual 2)



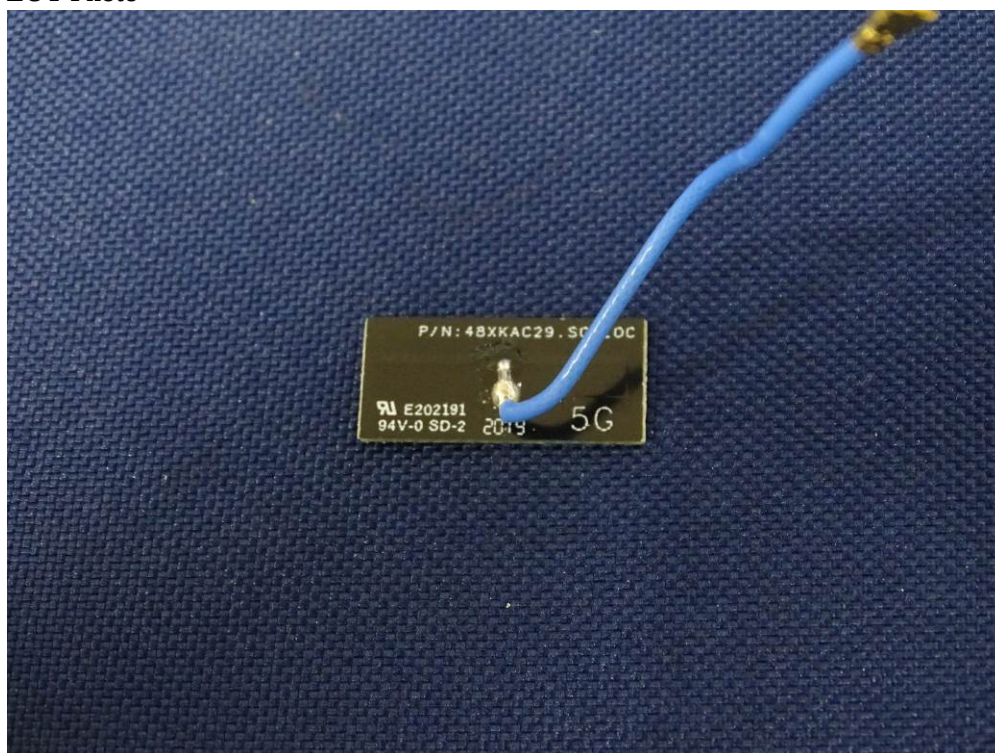
(39) EUT Photo



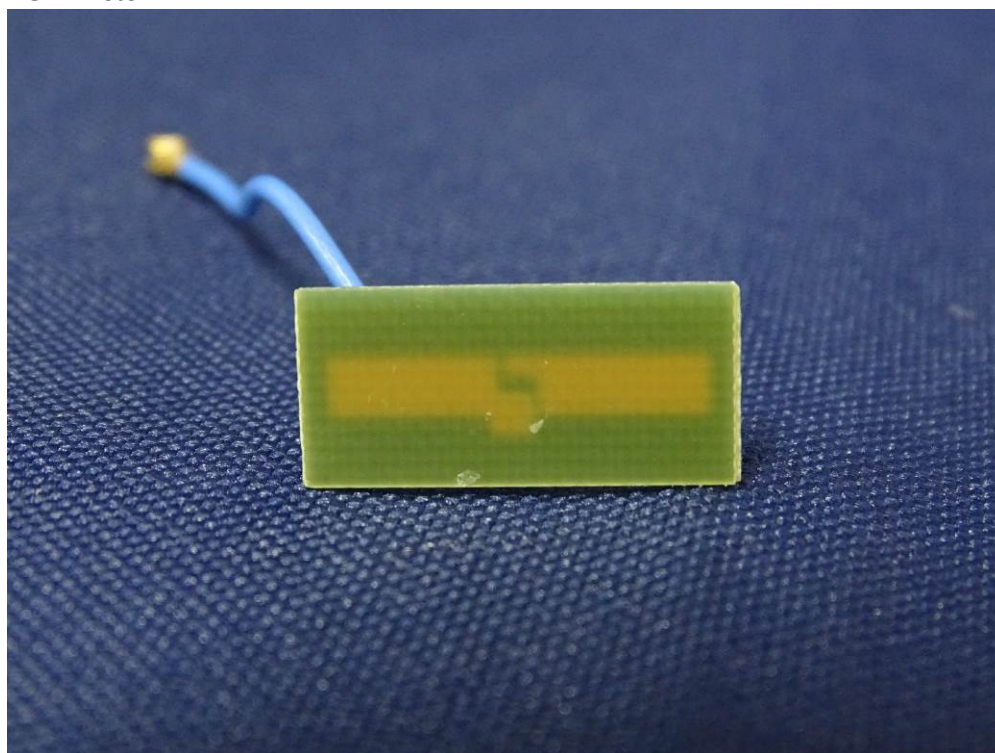
(40) EUT Photo (5G 1)



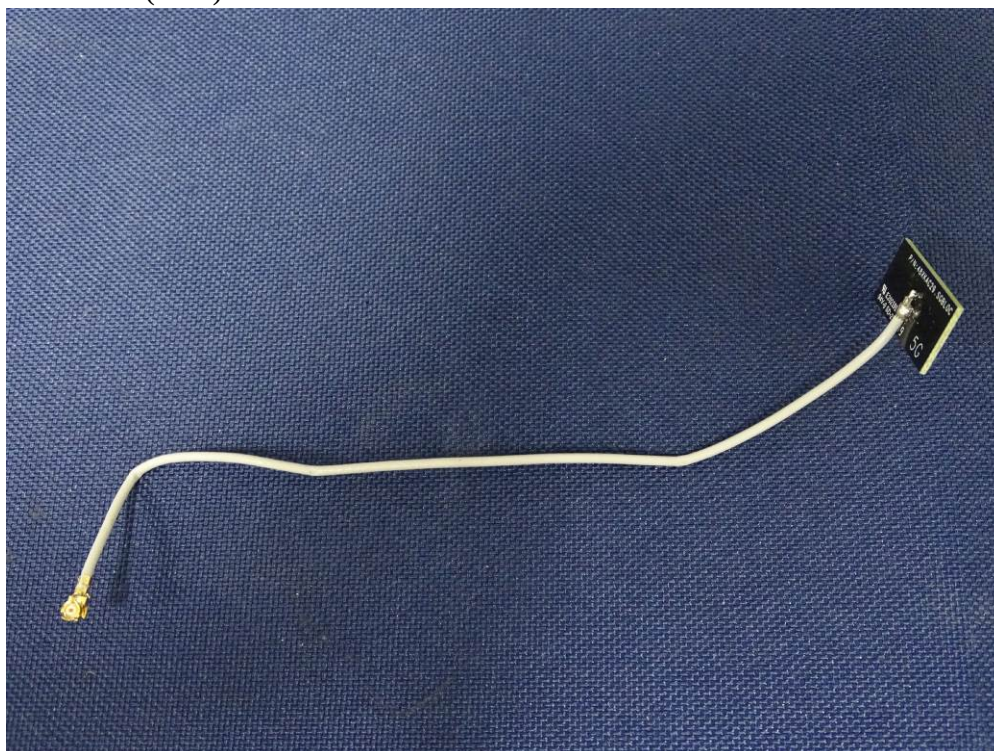
(41) EUT Photo



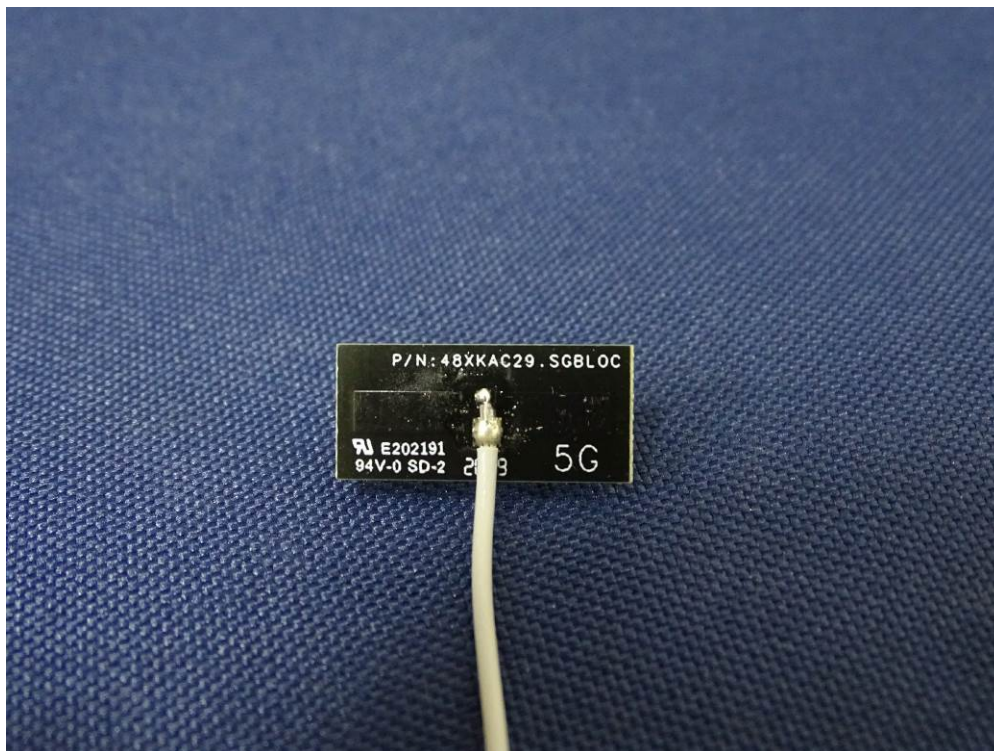
(42) EUT Photo



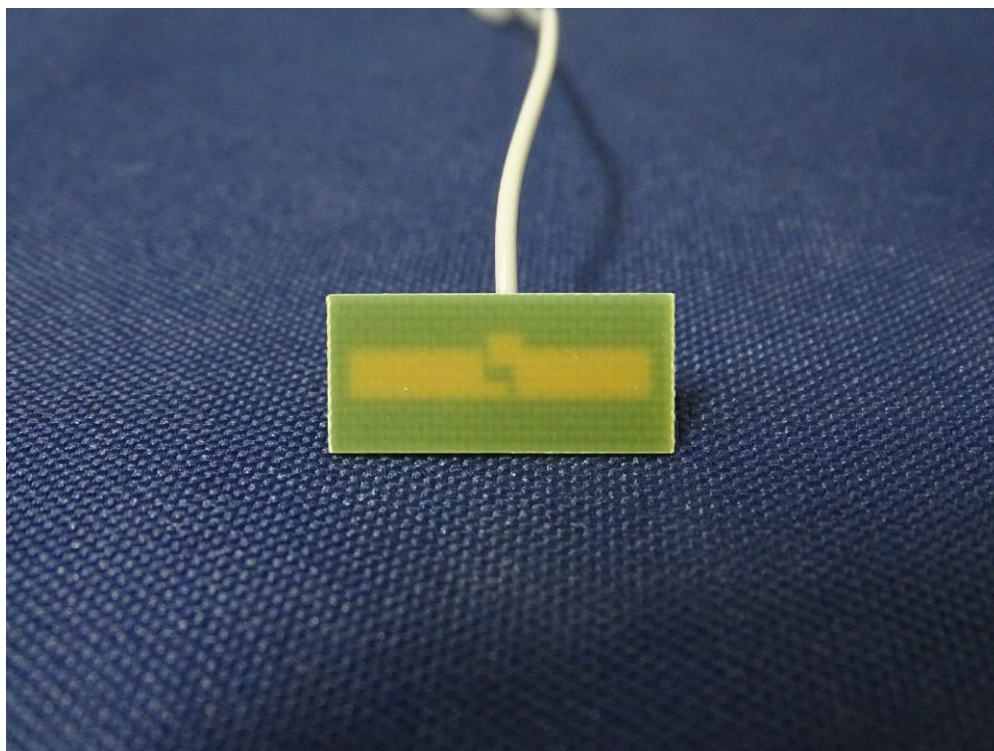
(43) EUT Photo (5G 2)



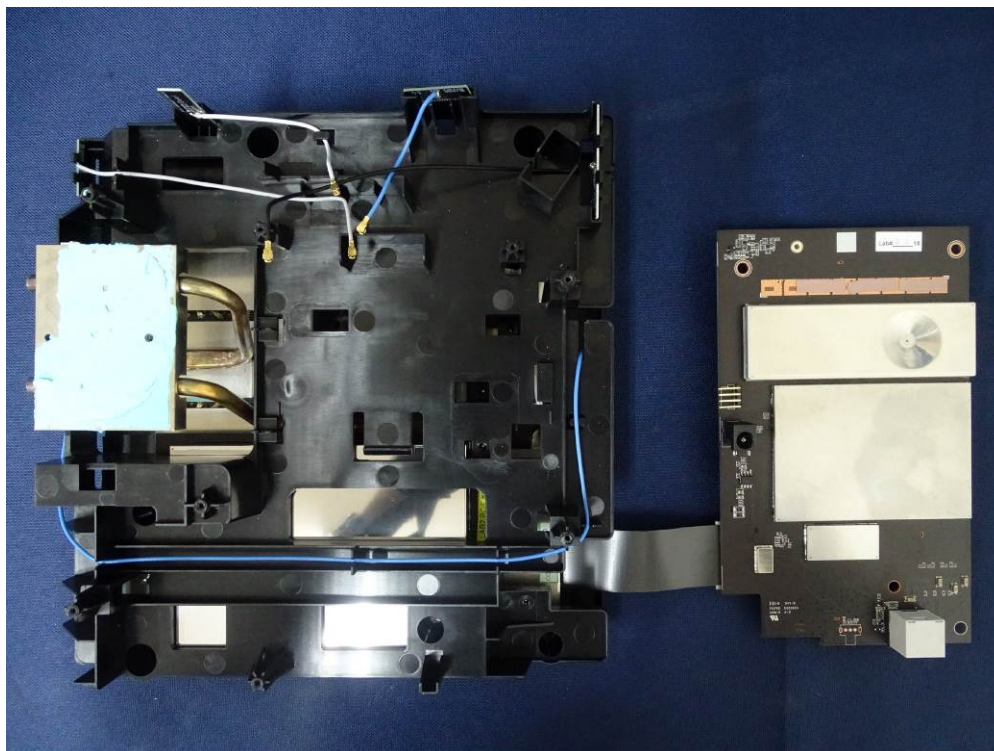
(44) EUT Photo



(45) EUT Photo



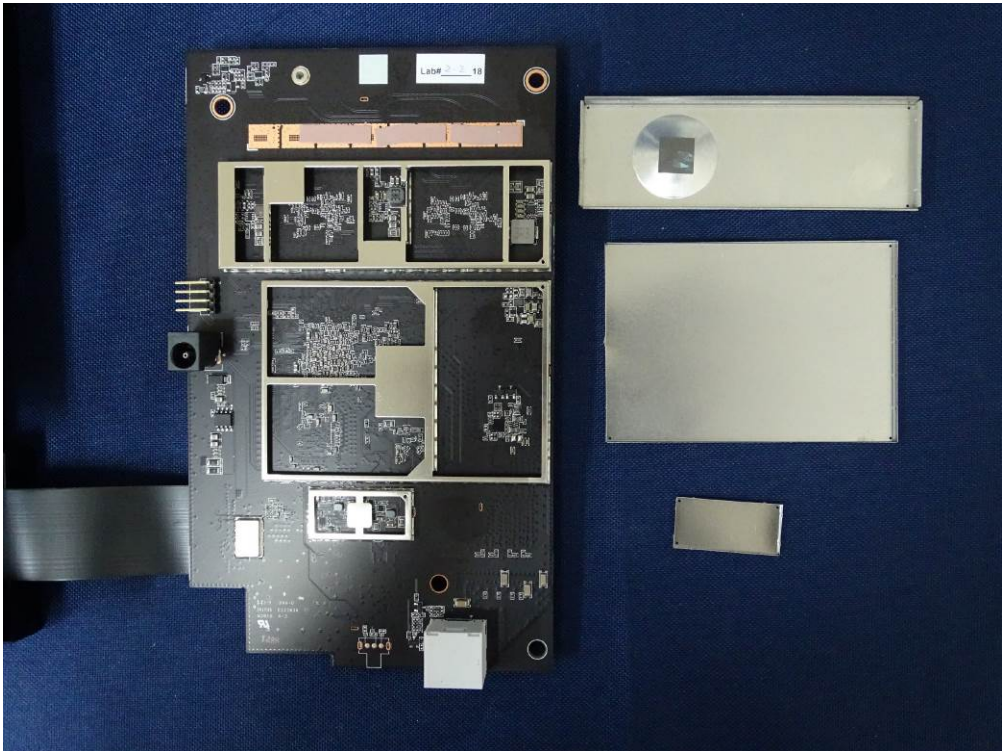
(46) EUT Photo



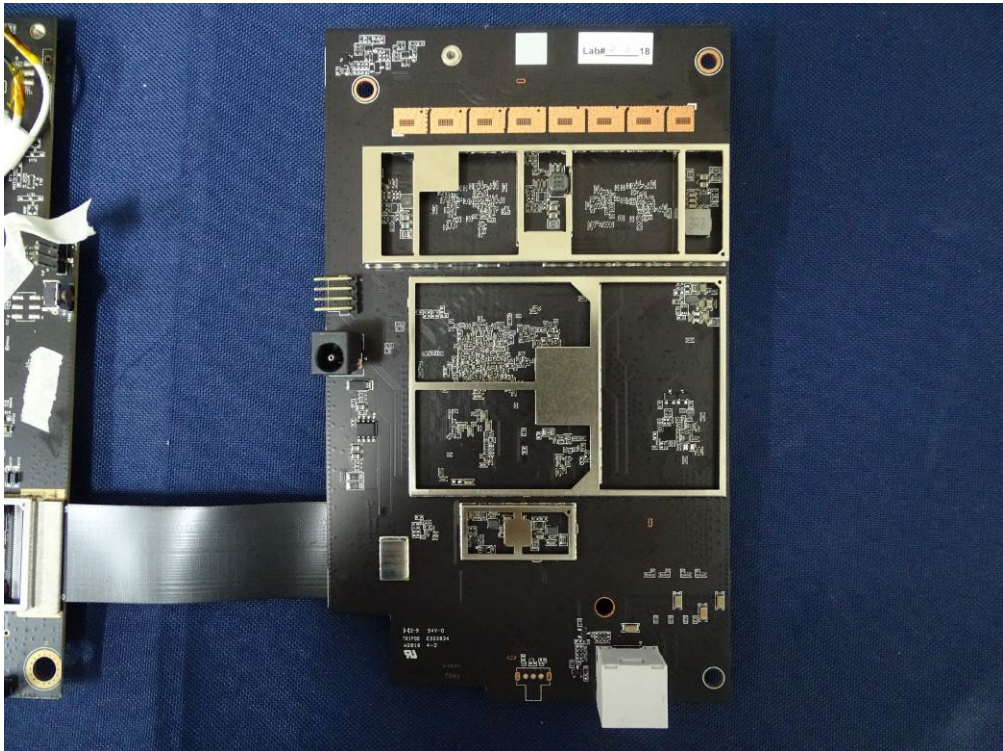
(47) EUT Photo



(48) EUT Photo



(49) EUT Photo



(50) EUT Photo

